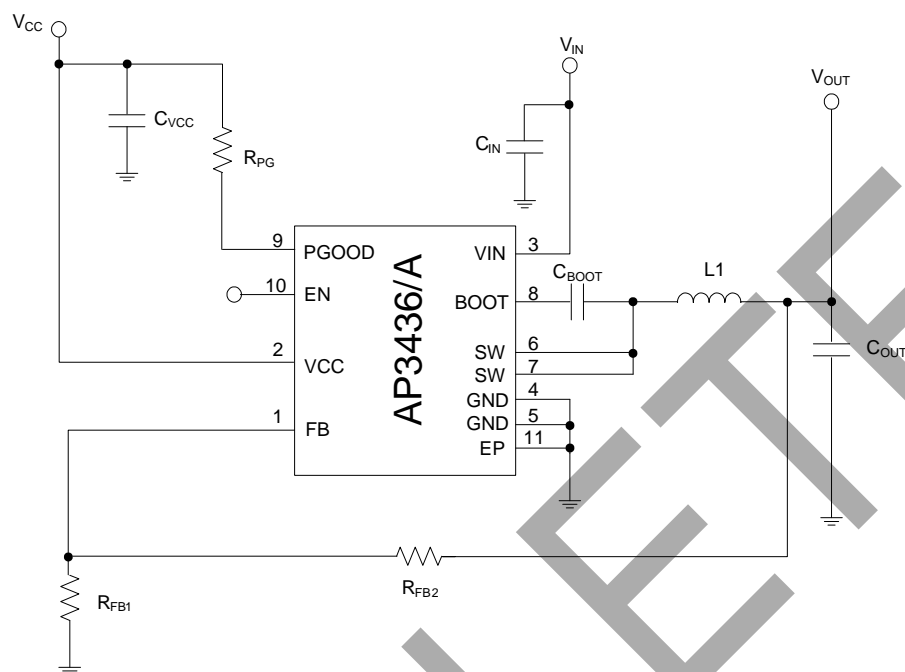


Typical Applications Circuit



Note 4: When using a single power supply for V_{CC} and V_{IN}, a 4.7Ω resistor should be placed between them for noise isolation.

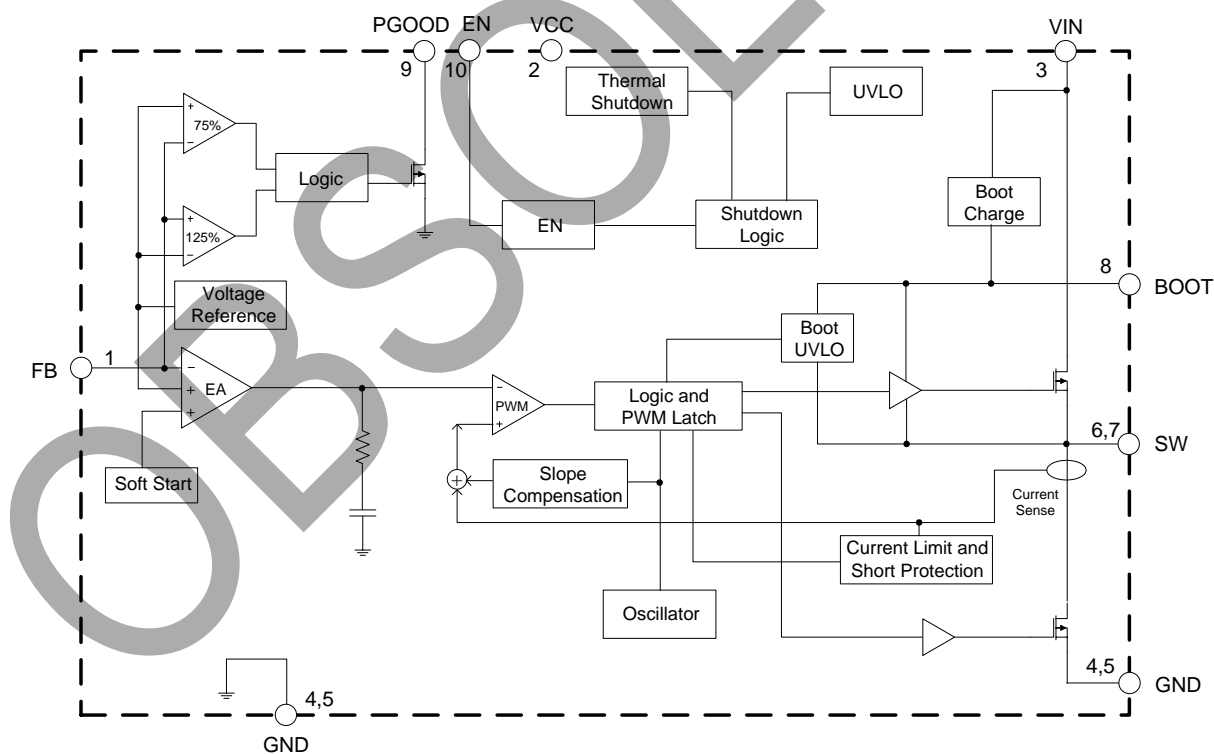
Component	Value	Unit	Component	Value	Unit
C _{VCC}	1	μF	C _{IN}	44	μF
R _{PG}	10	kΩ	C _{BOOT}	0.1	μF
R _{FB2}	TBD	kΩ	L1	1.5	μH
R _{FB1}	TBD	kΩ	C _{OUT}	88	μF

Table 1. Component Guide

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Pin Number	Pin Name	Function
1	FB	Voltage Feedback Input. Connect to V _{OUT} through a voltage divider to set the output voltage
2	VCC	Analog Power Input
3	VIN	Power Input
4, 5	GND	Ground. Must be Connected to GND on PCB
6, 7	SW	Power Switch Output
8	BOOT	High Side Switch Driver Supply
9	PGOOD	Open Drain Power Good Output
10	EN	Enable
11	Exposed Pad	Thermal Connection to the PCB. Must be connected to GND on PCB

Functional Block Diagram



Absolute Maximum Ratings (Note 5)

Symbol	Parameter	Rating	Unit
V_{CC}, V_{IN}	VCC, VIN Pin Voltage	-0.3 to 6	V
V_{EN}	EN Pin Voltage	-0.3 to 6	V
V_{SW}	SW Pin Voltage	-0.3 to $V_{IN}+0.3$	V
$V_{SW_TRANSIENT}$	SW Pin Transient Voltage (<50ns)	-5 to $V_{IN}+5$	V
V_{FB}	FB Pin Voltage	-0.3 to 6	V
V_{PGD}	PGOOD Pin Voltage	-0.3 to 6	V
V_{BOOT_SW}	BOOT to SW Voltage	0 to 6	V
θ_{JA}	Thermal Resistance (Junction to Ambient, Simulation)	33	°C/W
θ_{JC}	Thermal Resistance (Junction to Case)	3	°C/W
T_J	Operating Junction Temperature	-40 to +150	°C
T_{STG}	Storage Temperature	-65 to +150	°C
T_{LEAD}	Lead Temperature (Soldering, 10sec)	+260	°C
V_{HBM}	ESD (Human Body Model)	2000	V
V_{MM}	ESD (Machine Model)	200	V

Note 5: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V_{CC}	Analog Input Voltage	3.0	5.5	V
V_{IN}	Power Input Voltage	1.3	5.5	V
$I_{OUT(MAX)}$	Maximum Output Current	3	—	A
V_{OUT}	Output Voltage	0.8	V_{IN}	V
T_A	Operating Ambient Temperature	-40	+85	°C

Electrical Characteristics ($V_{CC} = 5V$, $V_{IN} = 5V$, $T_A = +25^\circ C$, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
SUPPLY VOLTAGE (VCC, VIN PIN)						
VCC	Analog Power Input Voltage	–	3.0	–	5.5	V
VIN	Power Input Voltage	–	1.3	–	5.5	V
IQ	Quiescent Current	VFB = 1.5V, VCC = 5V, VIN = 5V	–	400	–	μA
ISHDN	Shutdown Supply Current	VEN = 0V, 3.0V ≤ VCC ≤ 5.5V, 1.3V ≤ VIN ≤ 5.5V	–	–	1	μA
POWER ON RESET						
VUVLO	Internal Under Voltage Lockout Threshold for VCC	–	–	2.75	2.85	V
VHYS_VCC	Internal Under Voltage Hysteresis for VCC	–	–	150	–	mV
VOLTAGE REFERENCE (FB PIN)						
VFB	Voltage Reference	3.0V ≤ VCC ≤ 5.5V	0.591	0.600	0.609	V
INTERNAL PWM FREQUENCY						
f	PWM Frequency	3.0V ≤ VCC ≤ 5.5V	1.0	1.25	1.5	MHz
MOSFET SPEC						
RON_H	High Side Switch On-resistance	VBOOT_SW = 5.0V	–	50	100	mΩ
		VBOOT_SW = 3.0V	–	70	140	mΩ
RON_L	Low Side Switch On-resistance	VCC = 5.0V	–	50	100	mΩ
		VCC = 3.0V	–	70	140	mΩ
CURRENT LIMIT						
ILIMIT	Current Limit Threshold	–	4.8	7.6	–	A
THERMAL SHUTDOWN						
TTSD	Thermal Shutdown	–	–	+160	–	°C
–	Hysteresis	–	–	+20	–	°C
BOOT SPEC (BOOT PIN)						
RBOOT	BOOT Charge Resistor	VCC = 5.0V	–	16	–	Ω
–	BOOT to SW UVLO	VCC = 3.0V	–	2.2	–	V
SOFT START						
tss	Soft Start Time	–	0.8	–	2	ms

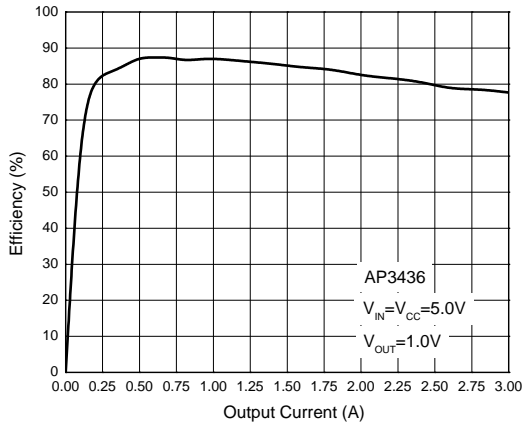
Electrical Characteristics (Cont. $V_{CC} = 5V$, $V_{IN} = 5V$, $T_A = +25^\circ C$, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
ENABLE (EN PIN)						
V _{EN_L}	EN Pin Threshold	–	–	–	0.8	V
V _{EN_H}		–	1.6	–	–	V
POWER GOOD (PGOOD PIN)						
V _{FBTH}	Feedback Threshold	V _{FB} falling (Fault)	70	75	–	%V _{REF}
		V _{FB} rising (Good)	77	82	–	
		V _{FB} rising (Fault)	–	125	130	
		V _{FB} falling (Good)	–	118	123	
t _{PG_DLY}	Delay Time for PGOOD from High to Low	–	–	30	–	μs
R _{PG}	Internal Power Good Pull Low Resistance	–	–	–	150	Ω
R _{PG_UP}	External Pull-up Resistance Range	–	3000	–	–	Ω
SYSTEM PERFORMANCE						
V _{UVP}	Output Under Voltage Protection Threshold	V _{IN} = 1.3 to 5.5V	–	–	0.5× V _{OUT}	V
t _{UVP}	Delay Time for UVP Triggered	V _{IN} = 1.5 to 5V	–	65	–	μs
V _{OVP}	Output Over Voltage Protection Threshold	V _{IN} = 1.3 to 5.5V	1.5× V _{OUT}	–	–	V
t _{OVP}	Delay Time for OVP Triggered	V _{IN} = 1.5 to 5V	–	65	–	μs
I _{OUT}	Output Current	V _{IN} = 1.5 to 5V, V _{OUT} = 1.0V	3	–	–	A
–	Output Voltage Line Regulation	V _{IN} = 1.5 to 5V, I _{OUT} = 100mA	–	0.4	–	%× V _{OUT} /V
–	Output Voltage Load Regulation	I _{OUT} = 0A to 3A	–	0.3	–	%× V _{OUT} /A
V _{TRAN}	Output Voltage Load Transient	V _{IN} = 5V, V _{OUT} = 1.0V, dl/dt = 400mA/μs	–	±2.5	–	%× V _{OUT} /A
η	Efficiency	V _{CC} = 5V, V _{IN} =5V, I _{OUT} = 3A, V _{OUT} = 1.2V	–	80	–	%

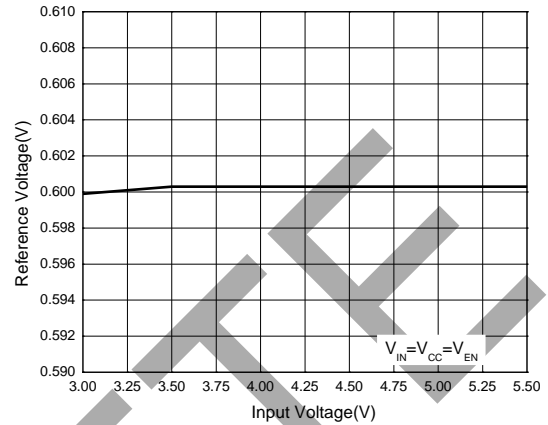
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Performance Characteristics

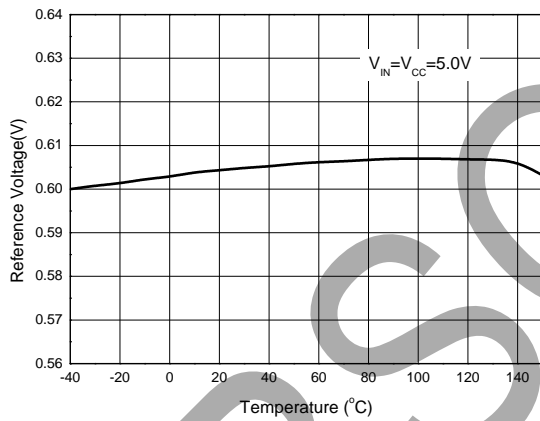
Efficiency vs. Output Current



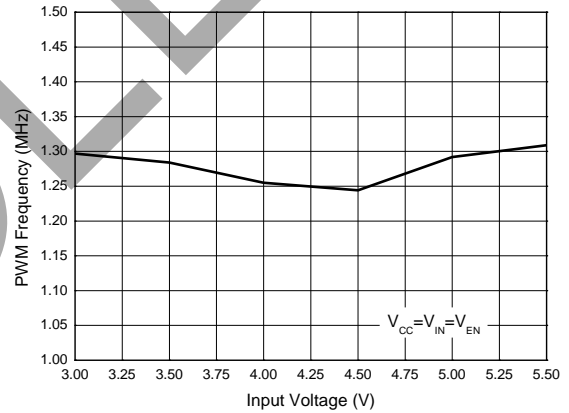
Reference Voltage vs. Input Voltage



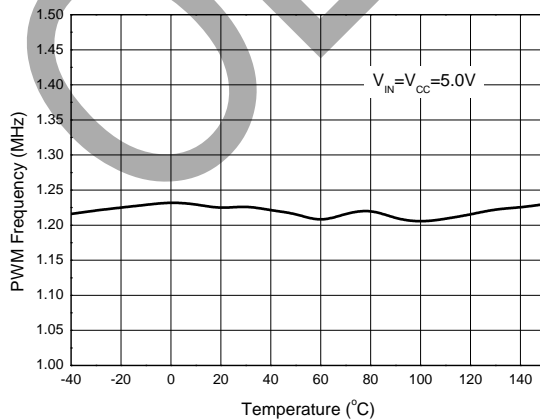
Reference Voltage vs. Temperature



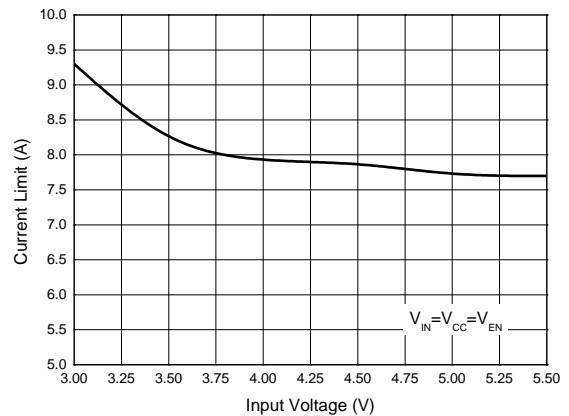
PWM Frequency vs. Input Voltage



PWM Frequency vs. Temperature

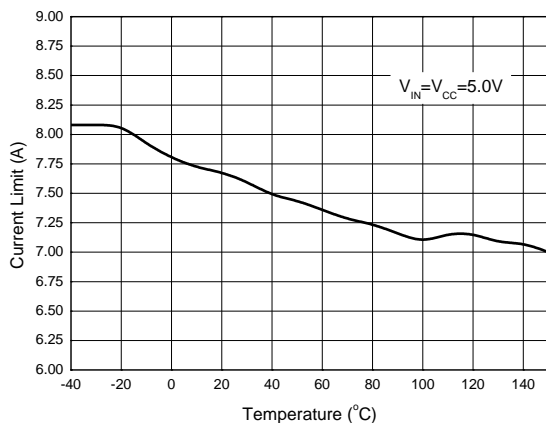


Current Limit vs. Input Voltage

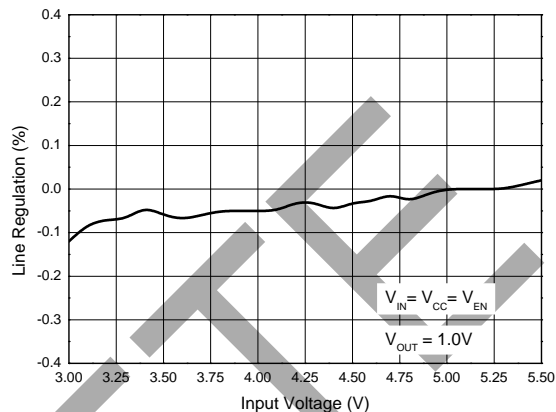


Performance Characteristics (Cont.)

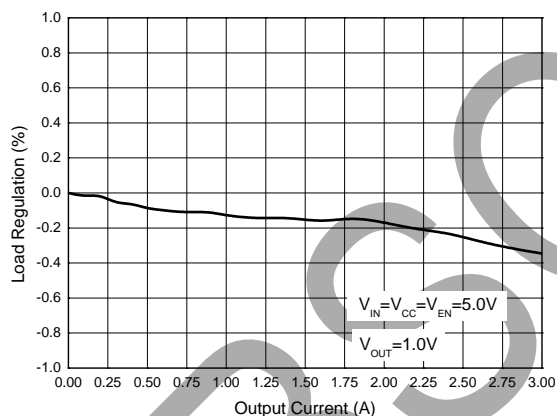
Current Limit vs. Temperature



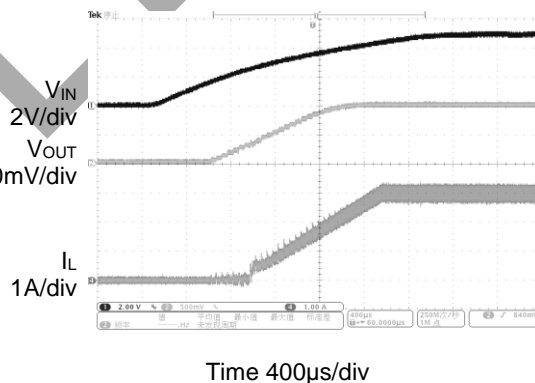
Line Regulation vs. Input Voltage



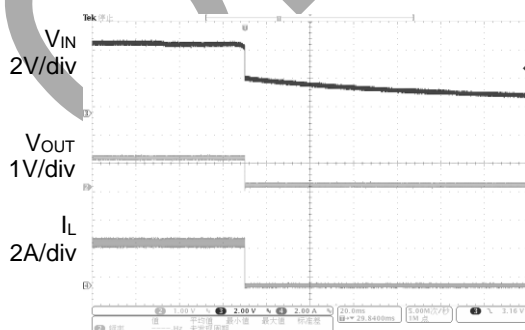
Load Regulation vs. Output Current



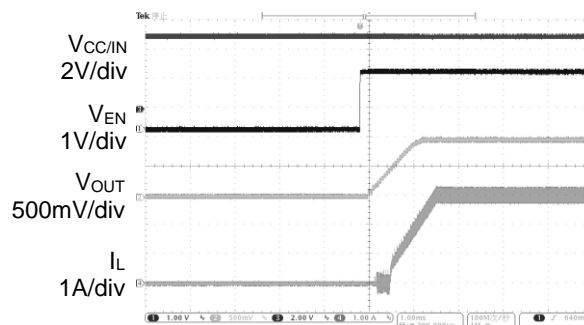
Power on Waveform
($V_{IN} = V_{CC} = 5V$, $V_{OUT} = 1V$, $I_{OUT} = 3A$)



Power off Waveform
($V_{IN} = V_{CC} = 5V$, $V_{OUT} = 1V$, $I_{OUT} = 3A$)

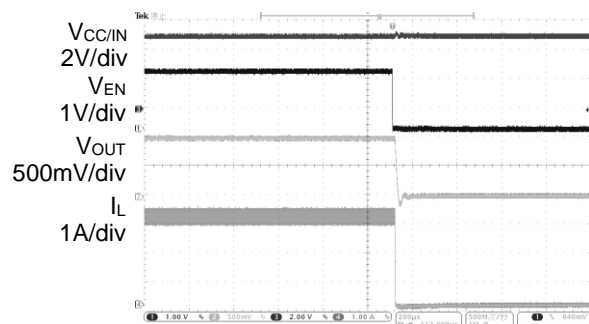


Enable Waveform
($V_{IN} = V_{CC} = 5V$, $V_{OUT} = 1V$, $I_{OUT} = 3A$)



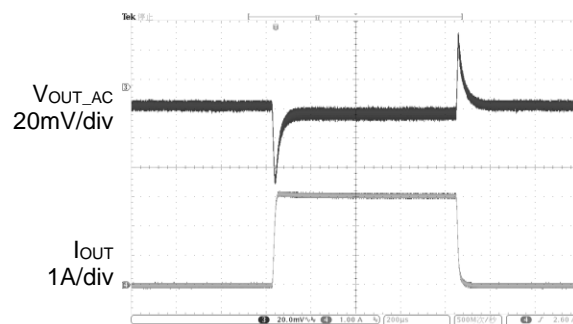
Performance Characteristics (Cont.)

Disable Waveform
($V_{IN}=V_{CC}=5V$, $V_{OUT}=1V$, $I_{OUT}=3A$)



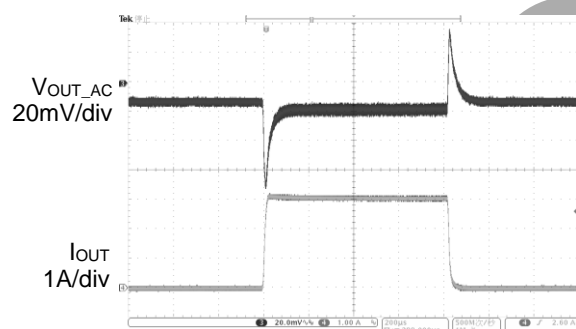
Time 200µs/div

Load Transient Response
($V_{IN}=V_{CC}=5V$, $V_{OUT}=1V$, $I_{OUT}=0$ to $3A$)



Time 200µs/div

Load Transient Response
($V_{IN}=V_{CC}=3.3V$, $V_{OUT}=1V$, $I_{OUT}=0$ to $3A$)



Time 200µs/div

Application Information

1. Overview

The AP3436/A is a 3A synchronous buck (step-down) converter with two integrated N-channel MOSFETs. For AP3436, the regulator operates in PWM mode with 1.25MHz switching frequency internally, regardless of if the load current is high or low. For AP3436A, when the load is very light, the regulator automatically operates in the PSM mode to minimize the switching loss, thus achieving high efficiency at light load. When the load increases, the regulator automatically switches over to a current-mode PWM operating at nominal 1.25MHz switching frequency.

2. Power On Reset

A Power On Reset (POR) circuitry continuously monitors the supply voltage at VCC pin. Once the rising POR threshold is exceeded, the AP3436/A sets itself to active state and is ready to accept chip enable command. The rising POR threshold is typically 2.75V.

3. Soft Start

A built-in soft-start is used to prevent surge current from power supply input VIN during turn on (Referring to the Functional Block Diagram). The error amplifier is a three-input device. Reference voltage VREF or the internal soft-start voltage VSS whichever is smaller dominates the behavior of the non-inverting inputs of the error amplifier. VSS internally ramps up to 0.6V after the soft-start cycle is initiated. The ramp is created digitally, so the output voltage will follow the VSS signal and ramps up smoothly to its target level.

4. EN Function

The AP3436/A provides Enable Function. Pulling this pin higher than 1.6V statically enables the AP3436/A while pulling the pin lower than 0.8V statically for longer than 10μs will shutdown the IC.

5. Adjusting Output Voltage

The output voltage is set with a resistor divider from the FB pin. It is recommended to use divider resistors with 1% tolerance or better. Start with a 100kΩ for the resistor R1 and use the following equation to calculate R2. Consider using larger value resistors to improve efficiency at very light loads. If the values are too high, the regulator is more susceptible to noise and the voltage errors caused by FB input current are noticeable.

$$R2 = \frac{R1 \times 0.6}{V_{OUT} - 0.6}$$

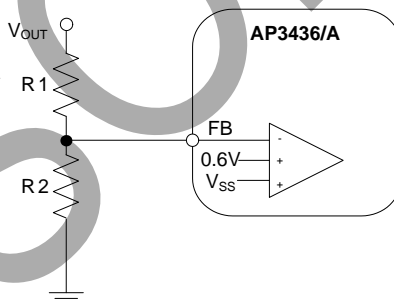


Figure 1. Voltage Divider Circuit

6. Short Circuit Protection (SCP)

The AP3436/A has Over Current Protection (OCP) and Under Voltage Protection (UVP) functions.

6.1 OCP Function

The high side switch current is detected during each cycle. During SCP conditions, the output voltage is pulled down and the switch current is increased. Once the increased high side switching current is detected to trigger the current limit of high side switch, the high side switch will be immediately turned off and will not be turned on again until the next switching cycle. When over current condition is removed, the AP3436/A will recover back to normal operation again.

6.2 UVP Function

The FB voltage is also monitored for Under Voltage Protection. The UV threshold is set at 0.2V. The under voltage protection has 65μs triggered delay. When UVP is triggered, both high side and low side are shutdown immediately. The UVP is a latched function, reset power supply or EN pin to restart AP3436/A again.

Application Information (Cont.)

7. Over Voltage Protection (OVP)

The output voltage is continuously monitored for Over Voltage Protection by FB pin. When it is larger than 1.67 times as setting, the OVP function is triggered. The Over Voltage Protection has 65 μ s triggered delay.

When OVP is triggered, both high side and low side are shutdown immediately and the output voltage is discharged by an internal 1k Ω resistor.

8. Power Good

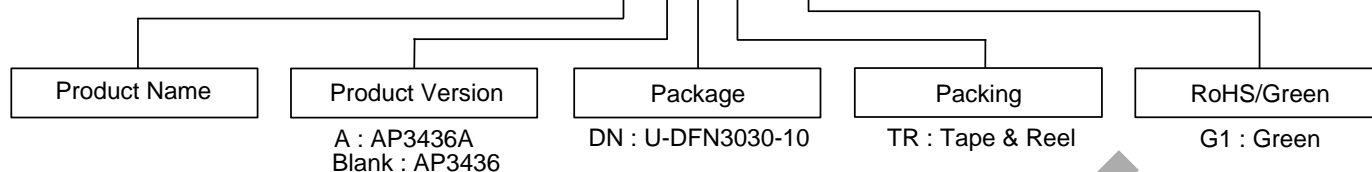
The PGOOD pin output connects an open drain MOSFET. The output is pulled low when the FB voltage enters the fault condition by falling below 75% or rising above 125% of the nominal internal reference voltage. There is a 7% hysteresis on the threshold voltage, so when the FB voltage rises to the good condition above 82% or falls below 118% of the internal voltage reference the PGOOD output MOSFET is turned off. It is recommended to use a pull-up resistor between the values of 3k Ω and 100k Ω to a voltage source that is 5V or less.

9. Thermal Shutdown

The device implements an internal thermal shutdown to protect itself if the junction temperature exceeds +160°C. Switching is stopped when the junction temperature exceeds the thermal trip threshold. Once the die temperature decreases below +140°C, the device reinitiates the soft start operation. The thermal shutdown hysteresis is +20°C.

Ordering Information

AP3436X XX XX - XX

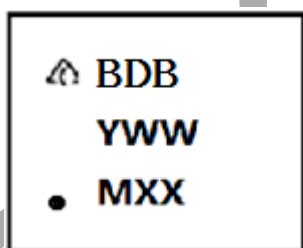


Package	Temperature Range	Function	Part Number	Marking ID	Packing
U-DFN3030-10	-40 to +85°C	PWM	AP3436DNTR-G1	BDB	5000/Tape & Reel
		PWM/PSM	AP3436ADNTR-G1	BDF	5000/Tape & Reel

Marking Information

AP3436

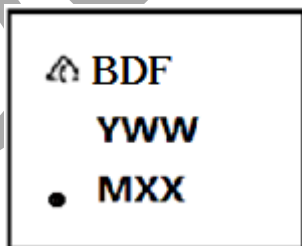
(Top View)



First Line: Logo and Marking ID
 Second and Third Lines: Date Code
 Y: Year
 WW: Work Week of Molding
 M: Assembly House Code
 XX: 7th and 8th Digits of Batch No.

AP3436A

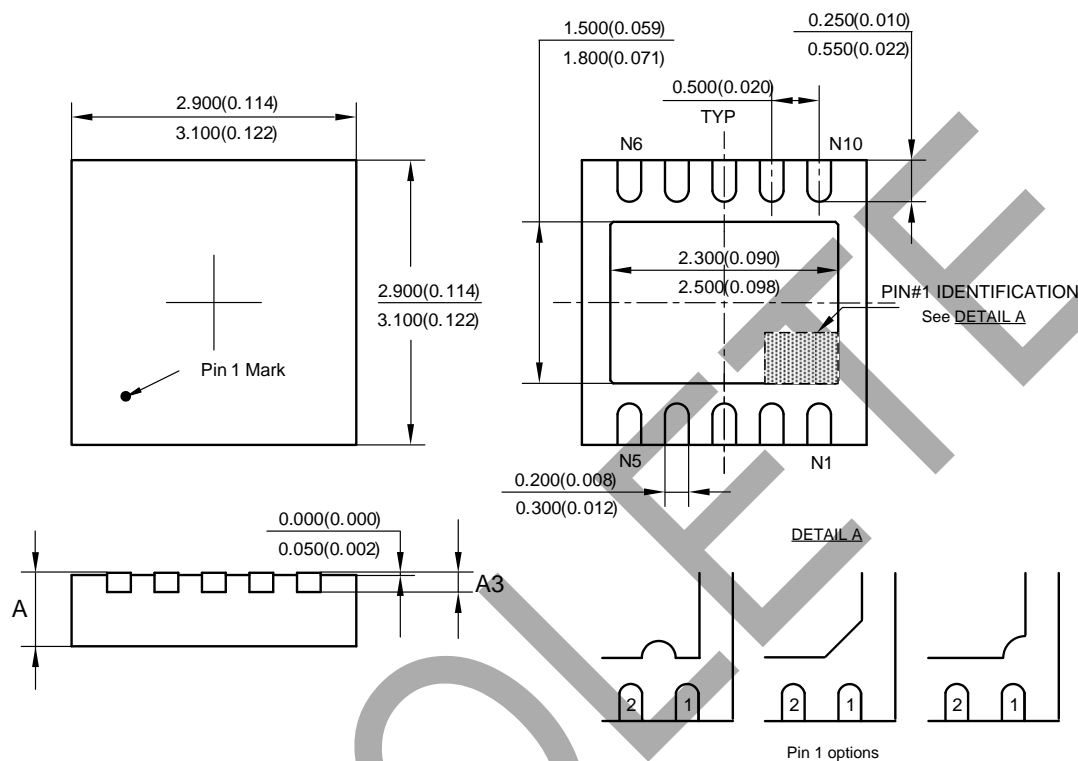
(Top View)



First Line: Logo and Marking ID
 Second and Third Lines: Date Code
 Y: Year
 WW: Work Week of Molding
 M: Assembly House Code
 XX: 7th and 8th Digits of Batch No.

Package Outline Dimensions (All dimensions in mm(inch).)

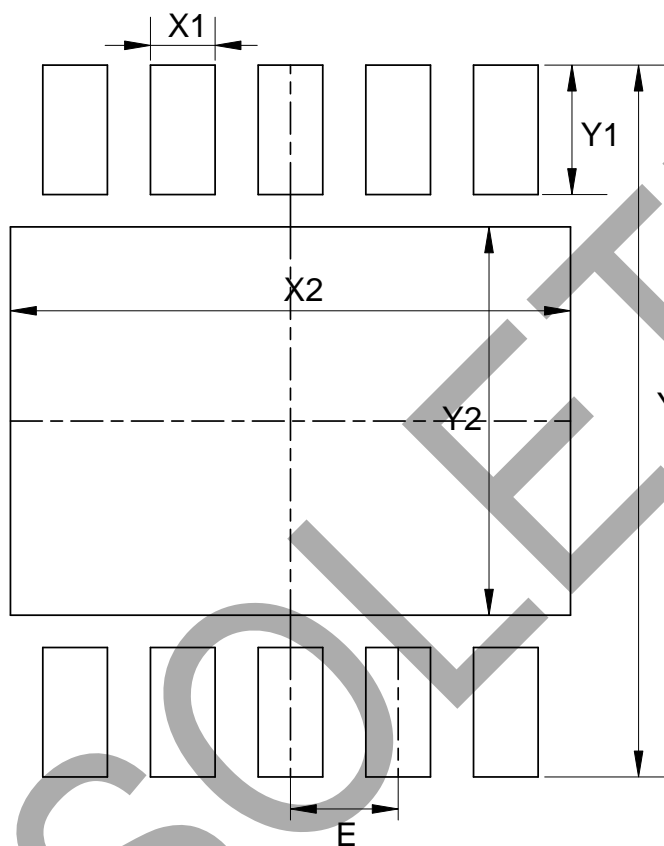
(1) Package Type: U-DFN3030-10



Symbol	A				A3			
	min(mm)	max(mm)	min(inch)	max(inch)	min(mm)	max(mm)	min(inch)	max(inch)
Option 1	0.700	0.800	0.028	0.031	0.153	0.253	0.006	0.010
Option 2	0.570	0.630	0.022	0.025	0.150 (Typ)	0.006 (Typ)		

Suggested Pad Layout

(1) Package Type: U-DFN3030-10



Dimensions	Y (mm)/(inch)	X1 (mm)/(inch)	Y1 (mm)/(inch)	X2 (mm)/(inch)	Y2 (mm)/(inch)	E (mm)/(inch)
Value	3.300/0.130	0.300/0.012	0.600/0.024	2.600/0.102	1.800/0.071	0.500/0.020

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